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STMicroelectronics International N.V.

Chemin du Champ-des-Filles, 39
CH-1228 GENEVA, Plan-les-Ouates
SWITZERLAND

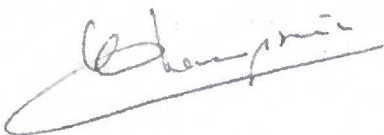
STMicroelectronics Statement on Conflict Minerals

STMicroelectronics has been actively managing the issue of conflict minerals within its supply chain since 2007.

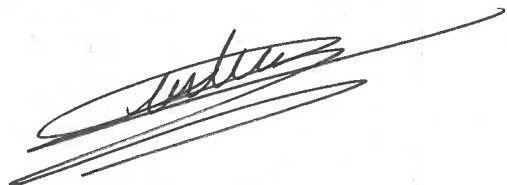
Several metals that are essential for our production process, Tantalum, Tungsten, Gold and Tin, may originate from minerals which are mined in the eastern provinces of the Democratic Republic of Congo (DRC) and surrounding regions, where armed conflict has given rise to a variety of serious human rights violations during recent years.

We believe that we can best play a part in locating and promoting responsible sources of these minerals by working in collaboration with other electronics companies through our membership of the Electronic Industry Citizenship Coalition (EICC). We are also committed to full compliance with United States legislation that requires companies which are publicly-traded on the US Securities and Exchange Commission to annually disclose information on the use of conflict minerals in their products ([SEC Filings on Conflict Minerals](#)).

To meet this commitment, we have put in place a due diligence process to map our supply chain and trace the origin of these metals, using the [EICC-GeSI Due Diligence tool](#) to engage relevant first-tier and sub-tier suppliers. We require smelters within our supply chain to take part in the [EICC-GeSI Conflict Free Smelter Program](#) or equivalent smelter audit initiatives. In this way we do our best to obtain validated assurance that metals within our supply chain are conflict-free. Detailed information about our supply chain sources and validation are disclosed to our customers on request. Our progress on this topic is publicly reported in our annual Sustainability Report.



Jean-Louis CHAMPSEIX
Group Vice-President
Corporate Social Responsibility



Patrick PEUBEZ
Executive Vice President
Product Quality Excellence